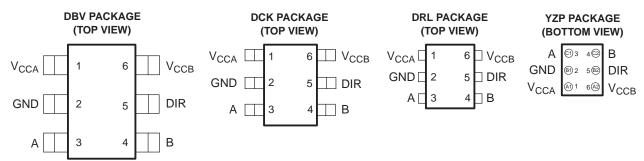
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FEATURES

- Available in the Texas Instruments
 NanoFree™ Package
- Fully Configurable Dual-Rail Design Allows Each Port to Operate Over the Full 1.65-V to 5.5-V Power-Supply Range
- V_{CC} Isolation Feature If Either V_{CC} Input Is at GND, Both Ports Are in the High-Impedance State
- DIR Input Circuit Referenced to V_{CCA}
- Low Power Consumption, 4-μA Max I_{CC}
- ±24-mA Output Drive at 3.3 V
- I_{off} Supports Partial-Power-Down Mode Operation

- Max Data Rates
 - 420 Mbps (3.3-V to 5-V Translation)
 - 210 Mbps (Translate to 3.3 V)
 - 140 Mbps (Translate to 2.5 V)
 - 75 Mbps (Translate to 1.8 V)
- Latch-Up Performance Exceeds 100 mA Per JESD 78, Class II
- ESD Protection Exceeds JESD 22
 - 2000-V Human-Body Model (A114-A)
 - 200-V Machine Model (A115-A)
 - 1000-V Charged-Device Model (C101)



See mechanical drawings for dimensions.

DESCRIPTION/ORDERING INFORMATION

This single-bit noninverting bus transceiver uses two separate configurable power-supply rails. The A port is designed to track V_{CCA} . V_{CCA} accepts any supply voltage from 1.65 V to 5.5 V. The B port is designed to track V_{CCB} . V_{CCB} accepts any supply voltage from 1.65 V to 5.5 V. This allows for universal low-voltage bidirectional translation between any of the 1.8-V, 2.5-V, 3.3-V, and 5-V voltage nodes.

ORDERING INFORMATION

| T _A | PACKAGE ⁽¹⁾ | | ORDERABLE PART NUMBER | TOP-SIDE MARKING(2) |
|----------------|--|--------------|-----------------------|---------------------|
| | NanoFree [™] – WCSP (DSBGA) 0.23-mm Large Bump – YZP (Pb-free) | Reel of 3000 | SN74LVC1T45YZPR | TA_ |
| | SOT (SOT-23) – DBV | Reel of 3000 | SN74LVC1T45DBVR | CT1 |
| -40°C to 85°C | 301 (301-23) | Reel of 250 | SN74LVC1T45DBVT | CII_ |
| | SOT (SC-70) – DCK | Reel of 3000 | SN74LVC1T45DCKR | |
| | 301 (30-70) - DCK | Reel of 250 | SN74LVC1T45DCKT | TA_ |
| | SOT (SOT-533) – DRL | Reel of 4000 | SN74LVC1T45DRLR | |

⁽¹⁾ Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

NanoFree is a trademark of Texas Instruments.

⁽²⁾ DBV/DCK/DRL: The actual top-side marking has one additional character that designates the assembly/test site. YZP: The actual top-side marking has three preceding characters to denote year, month, and sequence code, and one following character to designate the assembly/test site. Pin 1 identifier indicates solder-bump composition (1 = SnPb, • = Pb-free).

WITH CONFIGURABLE VOLTAGE TRANSLATION AND 3-STATE OUTPUTS



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DESCRIPTION/ORDERING INFORMATION (CONTINUED)

The SN74LVC1T45 is designed for asynchronous communication between two data buses. The logic levels of the direction-control (DIR) input activate either the B-port outputs or the A-port outputs. The device transmits data from the A bus to the B bus when the B-port outputs are activated and from the B bus to the A bus when the A-port outputs are activated. The input circuitry on both A and B ports always is active and must have a logic HIGH or LOW level applied to prevent excess I_{CC} and I_{CCZ}.

The SN74LVC1T45 is designed so that the DIR input is powered by V_{CCA}.

This device is fully specified for partial-power-down applications using I_{off} . The I_{off} circuitry disables the outputs, preventing damaging current backflow through the device when it is powered down.

The V_{CC} isolation feature ensures that if either V_{CC} input is at GND, then both ports are in the high-impedance state.

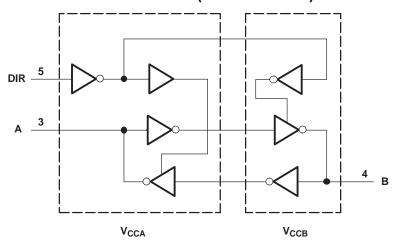
NanoFree[™] package technology is a major breakthrough in IC packaging concepts, using the die as the package.

FUNCTION TABLE(1)

| INPUT DIR | OPERATION |
|--------------|-----------------|
| L | B data to A bus |
| Н | A data to B bus |

(1) Input circuits of the data I/Os always are active.

LOGIC DIAGRAM (POSITIVE LOGIC)





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Absolute Maximum Ratings(1)

over operating free-air temperature range (unless otherwise noted)

| | | | MIN | MAX | UNIT |
|------------------|---|-----------------------------|------|------------------------|------|
| V_{CCA} | Supply voltage range | | -0.5 | 6.5 | V |
| V_{I} | Input voltage range ⁽²⁾ | | -0.5 | 6.5 | V |
| Vo | Voltage range applied to any output in the high-impedance or pow | er-off state ⁽²⁾ | -0.5 | 6.5 | V |
| \/ | Valtage range applied to any output in the high or law state (2)(3) | A port | -0.5 | V _{CCA} + 0.5 | V |
| Vo | Voltage range applied to any output in the high or low state (2)(3) | B port | -0.5 | V _{CCB} + 0.5 | V |
| I _{IK} | Input clamp current | V ₁ < 0 | | -50 | mA |
| I _{OK} | Output clamp current | V _O < 0 | | -50 | mA |
| Io | Continuous output current | | | ±50 | mA |
| | Continuous current through V _{CC} or GND | | | ±100 | mA |
| | | DBV package | | 165 | |
| 0 | Deckage thermal impedance (4) | DCK package | | 259 | °C/M |
| θ_{JA} | Package thermal impedance (4) | DRL package | | 142 | °C/W |
| | | YZP package | | 123 | |
| T _{stg} | Storage temperature range | | -65 | 150 | °C |

⁽¹⁾ Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability. The input and output negative-voltage ratings may be exceeded if the input and output clamp-current ratings are observed.

The value of V_{CC} is provided in the recommended operating conditions table.

⁽⁴⁾ The package thermal impedance is calculated in accordance with JESD 51-7.



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Recommended Operating Conditions (1)(2)(3)

| | | | V _{CCI} | V _{cco} | MIN | MAX | UNIT |
|-----------------|---------------------------|--|------------------|------------------|------------------------------|-----------------------|------|
| V_{CCA} | Supply voltage | | | | 1.65 | 5.5 | V |
| V_{CCB} | Supply voltage | | | | 1.65 | 5.5 | V |
| | | | 1.65 V to 1.95 V | | $V_{\text{CCI}} \times 0.65$ | | |
| V | High-level | Data inputs ⁽⁴⁾ | 2.3 V to 2.7 V | | 1.7 | | V |
| V_{IH} | input voltage | Data Inputs (4) | 3 V to 3.6 V | | 2 | | V |
| | | | 4.5 V to 5.5 V | | $V_{CCI} \times 0.7$ | | |
| | | | 1.65 V to 1.95 V | | | $V_{CCI} \times 0.35$ | |
| V | Low-level | Data in auto (4) | 2.3 V to 2.7 V | | | 0.7 | V |
| V_{IL} | input voltage | Data inputs ⁽⁴⁾ | 3 V to 3.6 V | | | 0.8 | V |
| | | | 4.5 V to 5.5 V | | | $V_{CCI} \times 0.3$ | |
| | | | 1.65 V to 1.95 V | | $V_{CCA} \times 0.65$ | | |
| | High-level | DIR | 2.3 V to 2.7 V | | 1.7 | | |
| V_{IH} | input voltage | (referenced to V _{CCA}) ⁽⁵⁾ | 3 V to 3.6 V | | 2 | | V |
| | | | 4.5 V to 5.5 V | | $V_{CCA} \times 0.7$ | | |
| | | | 1.65 V to 1.95 V | | | $V_{CCA} \times 0.35$ | |
| ., | Low-level | DIR | 2.3 V to 2.7 V | | | 0.7 | ., |
| V_{IL} | input voltage | (referenced to V _{CCA}) ⁽⁵⁾ | 3 V to 3.6 V | | | 0.8 | V |
| | | | 4.5 V to 5.5 V | | | $V_{CCA} \times 0.3$ | |
| V _I | Input voltage | | | | 0 | 5.5 | V |
| Vo | Output voltage | | | | 0 | V _{cco} | V |
| | | | | 1.65 V to 1.95 V | | -4 | |
| | Libert Leviel evitevit ev | | | 2.3 V to 2.7 V | | -8 | A |
| I _{OH} | High-level output cu | irrent | | 3 V to 3.6 V | | -24 | mA |
| | | | | 4.5 V to 5.5 V | | -32 | |
| | | | | 1.65 V to 1.95 V | | 4 | |
| | Laurianal antonitan | | | 2.3 V to 2.7 V | | 8 | A |
| l _{OL} | Low-level output cu | rrent | | 3 V to 3.6 V | | 24 | mA |
| | | | | 4.5 V to 5.5 V | | 32 | |
| | | | 1.65 V to 1.95 V | | | 20 | |
| | | Input transition rise or fall rate | 2.3 V to 2.7 V | | | 20 | |
| Δt/Δν | | | 3 V to 3.6 V | | | 10 | ns/V |
| | noo or rail rate | | 4.5 V to 5.5 V | | | 5 | |
| | | Control inputs | 1.65 V to 5.5 V | | | 5 | |
| T_A | Operating free-air to | emperature | | | -40 | 85 | °C |

⁽¹⁾ V_{CCI} is the V_{CC} associated with the input port.
(2) V_{CCO} is the V_{CC} associated with the output port.
(3) All unused data inputs of the device must be held at V_{CCI} or GND to ensure proper device operation. Refer to the TI application report, *Implications of Slow or Floating CMOS Inputs*, literature number SCBA004.
(4) For V_{CCI} values not specified in the data sheet, V_{IH} min = V_{CCI} × 0.7 V, V_{IL} max = V_{CCI} × 0.3 V.
(5) For V_{CCI} values not specified in the data sheet, V_{IH} min = V_{CCA} × 0.7 V, V_{IL} max = V_{CCA} × 0.3 V.

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Electrical Characteristics (1)(2)

over recommended operating free-air temperature range (unless otherwise noted)

| DAD/ | METER | TEST CONDITI | ONE | V | V | Т | _A = 25°C | | –40°C to | 85°C | UNIT |
|-------------------------------|-----------------------------|--|--------------------|------------------|------------------|-----|---------------------|-----|---------------------------|------|------|
| FARA | AIVIE I ER | TEST CONDITI | ONS | V _{CCA} | V _{CCB} | MIN | TYP | MAX | MIN | MAX | UNIT |
| | | $I_{OH} = -100 \ \mu A$ | | 1.65 V to 4.5 V | 1.65 V to 4.5 V | | | | V _{CCO} - 0.1 | | |
| | | $I_{OH} = -4 \text{ mA}$ | | 1.65 V | 1.65 V | | | | 1.2 | | |
| V_{OH} | | $I_{OH} = -8 \text{ mA}$ | $V_I = V_{IH}$ | 2.3 V | 2.3 V | | | | 1.9 | | V |
| | | $I_{OH} = -24 \text{ mA}$ | | 3 V | 3 V | | | | 2.4 | | |
| | | $I_{OH} = -32 \text{ mA}$ | | 4.5 V | 4.5 V | | | | 3.8 | | |
| | | I _{OL} = 100 μA | | 1.65 V to 4.5 V | 1.65 V to 4.5 V | | | | | 0.1 | |
| | | I _{OL} = 4 mA | | 1.65 V | 1.65 V | | | | | 0.45 | |
| V_{OL} | | I _{OL} = 8 mA | $V_I = V_{IL}$ | 2.3 V | 2.3 V | | | | | 0.3 | V |
| | | I _{OL} = 24 mA | | 3 V | 3 V | | | | | 0.55 | |
| | | I _{OL} = 32 mA | | 4.5 V | 4.5 V | | | | | 0.55 | |
| I _I | DIR | $V_I = V_{CCA}$ or GND | | 1.65 V to 5.5 V | 1.65 V to 5.5 V | | | ±1 | | ±2 | μΑ |
| | A port | \\ -=\\\ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ | , | 0 V | 0 to 5.5 V | | | ±1 | | ±2 | ^ |
| I _{off} | B port | $V_{\rm I}$ or $V_{\rm O} = 0$ to 5.5 V | | 0 to 5.5 V | 0 V | | | ±1 | | ±2 | μΑ |
| I _{OZ} | A or B port | $V_O = V_{CCO}$ or GND | | 1.65 V to 5.5 V | 1.65 V to 5.5 V | | | ±1 | | ±2 | μΑ |
| | | | | 1.65 V to 5.5 V | 1.65 V to 5.5 V | | | | | 3 | |
| I_{CCA} | | $V_I = V_{CCI}$ or GND, | I _O = 0 | 5.5 V | 0 V | | | | | 2 | μΑ |
| | | | | 0 V | 5.5 V | | | | | -2 | |
| | | | | 1.65 V to 5.5 V | 1.65 V to 5.5 V | | | | | 3 | |
| I_{CCB} | | $V_I = V_{CCI}$ or GND, | I _O = 0 | 5.5 V | 0 V | | | | | -2 | μΑ |
| | | | | 0 V | 5.5 V | | | | | 2 | |
| I _{CCA} + (see Ta | I _{CCB} able 1) | $V_I = V_{CCI}$ or GND, | I _O = 0 | 1.65 V to 5.5 V | 1.65 V to 5.5 V | | | | | 4 | μΑ |
| | A port | A port at V _{CCA} – 0.6 DIR at V _{CCA} , B port | V, = open | | | | | | | 50 | |
| Δl _{CCA} | DIR | DIR at V _{CCA} - 0.6 V, B port = open, A port at V _{CCA} or GN | , | 3 V to 5.5 V | 3 V to 5.5 V | | | | | 50 | μΑ |
| ΔI_{CCB} | B port | B port at V _{CCB} – 0.6 DIR at GND, A port = open | V, | 3 V to 5.5 V | 3 V to 5.5 V | | | | | 50 | μΑ |
| Ci | DIR | $V_I = V_{CCA}$ or GND | | 3.3 V | 3.3 V | | 2.5 | | | | рF |
| C _{io} | A or B port | V _O = V _{CCA/B} or GND |) | 3.3 V | 3.3 V | | 6 | | | | pF |

 $[\]begin{array}{ll} \hbox{(1)} & V_{CCO} \text{ is the } V_{CC} \text{ associated with the output port.} \\ \hbox{(2)} & V_{CCI} \text{ is the } V_{CC} \text{ associated with the input port.} \\ \end{array}$

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Switching Characteristics

over recommended operating free-air temperature range, V_{CCA} = 1.8 V \pm 0.15 V (see Figure 1)

| PARAMETER | FROM (INPUT) | TO (OUTPUT) | V _{CCB} = 1.8 V ± 0.15 V | | V _{CCB} = ± 0.2 | | V _{CCB} = 3 ± 0.3 | | V _{CCB} = ± 0.5 | | UNIT |
|---------------------------------|-----------------|----------------|--------------------------------------|------|-----------------------------|------|-------------------------------|------|-----------------------------|------|------|
| | (INPOT) | (001701) | MIN | MAX | MIN | MAX | MIN | MAX | MIN | MAX | |
| t _{PLH} | А | В | 3 | 17.7 | 2.2 | 10.3 | 1.7 | 8.3 | 1.4 | 7.2 | 20 |
| t _{PHL} | A | ь | 2.8 | 14.3 | 2.2 | 8.5 | 1.8 | 7.1 | 1.7 | 7 | ns |
| t _{PLH} | В | Α | 3 | 17.7 | 2.3 | 16 | 2.1 | 15.5 | 1.9 | 15.1 | ns |
| t _{PHL} | ь | A | 2.8 | 14.3 | 2.1 | 12.9 | 2 | 12.6 | 1.8 | 12.2 | 115 |
| t _{PHZ} | DIR | Α | 5.2 | 19.4 | 4.8 | 18.5 | 4.7 | 18.4 | 5.1 | 17.1 | 20 |
| t _{PLZ} | DIK | A | 2.3 | 10.5 | 2.1 | 10.5 | 2.4 | 10.7 | 3.1 | 10.9 | ns |
| t _{PHZ} | DIR | В | 7.4 | 21.9 | 4.9 | 11.5 | 4.6 | 10.3 | 2.8 | 8.2 | 20 |
| t _{PLZ} | DIK | ь | 4.2 | 16 | 3.7 | 9.2 | 3.3 | 8.4 | 2.4 | 6.4 | ns |
| t _{PZH} ⁽¹⁾ | DIR | Α | | 33.7 | | 25.2 | | 23.9 | | 21.5 | 20 |
| t _{PZL} ⁽¹⁾ | אוט | A | | 36.2 | | 24.4 | | 22.9 | | 20.4 | ns |
| t _{PZH} ⁽¹⁾ | DIR | В | | 28.2 | | 20.8 | | 19 | | 18.1 | |
| t _{PZL} ⁽¹⁾ | אוע | D D | | 33.7 | | 27 | | 25.5 | | 24.1 | ns |

⁽¹⁾ The enable time is a calculated value, derived using the formula shown in the *enable times* section.

Switching Characteristics

over recommended operating free-air temperature range, V_{CCA} = 2.5 V \pm 0.2 V (see Figure 1)

| PARAMETER | FROM (INPUT) | TO (OUTPUT) | V _{CCB} = ± 0.15 | 1.8 V 5 V | V _{CCB} = ± 0.2 | | V _{CCB} = ± 0.3 | 3.3 V V | V _{CCB} = ± 0.5 | 5 V V | UNIT |
|---------------------------------|-----------------|----------------|---------------------------|--------------|-----------------------------|------|--------------------------|------------|-----------------------------|----------|------|
| | (INPOT) | (001F01) | MIN | MAX | MIN | MAX | MIN | MAX | MIN | MAX | |
| t _{PLH} | А | В | 2.3 | 16 | 1.5 | 8.5 | 1.3 | 6.4 | 1.1 | 5.1 | no |
| t _{PHL} | A | ь | 2.1 | 12.9 | 1.4 | 7.5 | 1.3 | 5.4 | 0.9 | 4.6 | ns |
| t _{PLH} | В | Α | 2.2 | 10.3 | 1.5 | 8.5 | 1.4 | 8 | 1 | 7.5 | no |
| t _{PHL} | ь | A | 2.2 | 8.5 | 1.4 | 7.5 | 1.3 | 7 | 0.9 | 6.2 | ns |
| t _{PHZ} | DIR | Α | 3 | 8.1 | 3.1 | 8.1 | 2.8 | 8.1 | 3.2 | 8.1 | ns |
| t_{PLZ} | DIK | A | 1.3 | 5.9 | 1.3 | 5.9 | 1.3 | 5.9 | 1 | 5.8 | 115 |
| t_{PHZ} | DIR | В | 6.5 | 23.7 | 4.1 | 11.4 | 3.9 | 10.2 | 2.4 | 7.1 | no |
| t_{PLZ} | DIK | ь | 3.9 | 18.9 | 3.2 | 9.6 | 2.8 | 8.4 | 1.8 | 5.3 | ns |
| t _{PZH} ⁽¹⁾ | DIR | Α | | 29.2 | | 18.1 | | 16.4 | | 12.8 | no |
| t _{PZL} ⁽¹⁾ | אוט | A | | 32.2 | | 18.9 | | 17.2 | | 13.3 | ns |
| t _{PZH} ⁽¹⁾ | DIR | В | | 21.9 | | 14.4 | | 12.3 | | 10.9 | no |
| t _{PZL} ⁽¹⁾ | DIK | В | | 21 | · | 15.6 | | 13.5 | | 12.7 | ns |

⁽¹⁾ The enable time is a calculated value, derived using the formula shown in the enable times section.

Switching Characteristics

over recommended operating free-air temperature range, V_{CCA} = 3.3 V \pm 0.3 V (see Figure 1)

| PARAMETER | FROM (INPUT) | TO (OUTPUT) | V _{CCB} = ± 0.15 | | V _{CCB} = ± 0.2 | | V _{CCB} = 3 ± 0.3 | | V _{CCB} = ± 0.5 | | UNIT |
|---------------------------------|-----------------|----------------|---------------------------|------|-----------------------------|------|-------------------------------|------|-----------------------------|------|------|
| | (INPOT) | | MIN | MAX | MIN | MAX | MIN | MAX | MIN | MAX | |
| t _{PLH} | А | В | 2.1 | 15.5 | 1.4 | 8 | 0.7 | 5.8 | 0.7 | 4.4 | no |
| t _{PHL} | A | ь | 2 | 12.6 | 1.3 | 7 | 0.8 | 5 | 0.7 | 4 | ns |
| t _{PLH} | В | А | 1.7 | 8.3 | 1.3 | 6.4 | 0.7 | 5.8 | 0.6 | 5.4 | no |
| t _{PHL} | ь | A | 1.8 | 7.1 | 1.3 | 5.4 | 0.8 | 5 | 0.7 | 4.5 | ns |
| t _{PHZ} | DIR | А | 2.9 | 7.3 | 3 | 7.3 | 2.8 | 7.3 | 3.4 | 7.3 | |
| t _{PLZ} | אוט | A | 1.8 | 5.6 | 1.6 | 5.6 | 2.2 | 5.7 | 2.2 | 5.7 | ns |
| t _{PHZ} | DIR | В | 5.4 | 20.5 | 3.9 | 10.1 | 2.9 | 8.8 | 2.4 | 6.8 | no |
| t _{PLZ} | DIK | ь | 3.3 | 14.5 | 2.9 | 7.8 | 2.4 | 7.1 | 1.7 | 4.9 | ns |
| t _{PZH} ⁽¹⁾ | DIR | А | | 22.8 | | 14.2 | | 12.9 | | 10.3 | no |
| t _{PZL} ⁽¹⁾ | DIK | A | | 27.6 | | 15.5 | | 13.8 | | 11.3 | ns |
| t _{PZH} ⁽¹⁾ | DIR | DIR B | | 21.1 | | 13.6 | | 11.5 | | 10.1 | no |
| t _{PZL} ⁽¹⁾ | אוט | В | | 19.9 | | 14.3 | | 12.3 | | 11.3 | ns |

⁽¹⁾ The enable time is a calculated value, derived using the formula shown in the *enable times* section.

Switching Characteristics

over recommended operating free-air temperature range, $V_{CCA} = 5 \text{ V} \pm 0.5 \text{ V}$ (see Figure 1)

| PARAMETER | FROM (INPUT) | TO (OUTPUT) | | V _{CCB} = 1.8 V ± 0.15 V | | 2.5 V ? V | V _{CCB} = 3 ± 0.3 | | V _{CCB} = ± 0.5 | 5 V V | UNIT | | | | | | | | | | | |
|---------------------------------|-----------------|----------------|-----|--------------------------------------|-----|--------------|-------------------------------|------|-----------------------------|----------|------|-----|-------|--|------|--|------|--|----|--|-----|----|
| | (INPOT) | (OUTPUT) | MIN | MAX | MIN | MAX | MIN | MAX | MIN | MAX | | | | | | | | | | | | |
| t _{PLH} | А | В | 1.9 | 15.1 | 1 | 7.5 | 0.6 | 5.4 | 0.5 | 3.9 | 20 | | | | | | | | | | | |
| t _{PHL} | A | ь | 1.8 | 12.2 | 0.9 | 6.2 | 0.7 | 4.5 | 0.5 | 3.5 | ns | | | | | | | | | | | |
| t _{PLH} | В | А | 1.4 | 7.2 | 1 | 5.1 | 0.7 | 4.4 | 0.5 | 3.9 | 20 | | | | | | | | | | | |
| t _{PHL} | ь | A | 1.7 | 7 | 0.9 | 4.6 | 0.7 | 4 | 0.5 | 3.5 | ns | | | | | | | | | | | |
| t _{PHZ} | DIR | А | 2.1 | 5.4 | 2.2 | 5.4 | 2.2 | 5.5 | 2.2 | 5.4 | ns | | | | | | | | | | | |
| t _{PLZ} | DIK | A | 0.9 | 3.8 | 1 | 3.8 | 1 | 3.7 | 0.9 | 3.7 | 115 | | | | | | | | | | | |
| t _{PHZ} | DIR | В | 4.8 | 20.2 | 2.5 | 9.8 | 1 | 8.5 | 2.5 | 6.5 | no | | | | | | | | | | | |
| t _{PLZ} | DIK | ь | 4.2 | 14.8 | 2.5 | 7.4 | 2.5 | 7 | 1.6 | 4.5 | ns | | | | | | | | | | | |
| t _{PZH} ⁽¹⁾ | DIR | А | | 22 | | 12.5 | | 11.4 | | 8.4 | 20 | | | | | | | | | | | |
| t _{PZL} ⁽¹⁾ | DIK | A | | 27.2 | | 14.4 | | 12.5 | | 10 | ns | | | | | | | | | | | |
| t _{PZH} ⁽¹⁾ | DIB | В | | 18.9 | | 11.3 | | 9.1 | | 7.6 | | | | | | | | | | | | |
| t _{PZL} ⁽¹⁾ | DIR | DIR | DIR | DIR | DIR | DIR | DIR | DIR | DIR | DIR | DIR | DIR | DIR B | | 17.6 | | 11.6 | | 10 | | 8.6 | ns |

⁽¹⁾ The enable time is a calculated value, derived using the formula shown in the enable times section.

Operating Characteristics

 $T_A = 25^{\circ}C$

| | PARAMETER | TEST CONDITIONS | V _{CCA} = V _{CCB} = 1.8 V | V _{CCA} = V _{CCB} = 2.5 V | V _{CCA} = V _{CCB} = 3.3 V | V _{CCA} = V _{CCB} = 5 V | UNIT |
|---------------------------------|-----------------------------|---|---|---|---|---|------|
| - (4) | A-port input, B-port output | $C_L = 0 pF$, | 3 | 4 | 4 | 4 | _ |
| C _{pdA} ⁽¹⁾ | B-port input, A-port output | f = 10 MHz, t _r = t _f = 1 ns | 18 | 19 | 20 | 21 | pF |
| - (4) | A-port input, B-port output | $C_L = 0 pF$, | 18 | 19 | 20 | 21 | |
| C _{pdB} ⁽¹⁾ | B-port input, A-port output | f = 10 MHz, $t_r = t_f = 1 ns$ | 3 | 4 | 4 | 4 | pF |

⁽¹⁾ Power dissipation capacitance per transceiver



Power-Up Considerations

A proper power-up sequence always should be followed to avoid excessive supply current, bus contention, oscillations, or other anomalies. To guard against such power-up problems, take the following precautions:

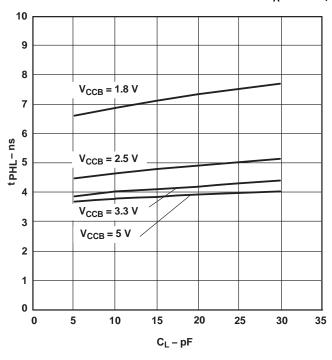
- 1. Connect ground before any supply voltage is applied.
- 2. Power up V_{CCA}.
- 3. V_{CCB} can be ramped up along with or after V_{CCA} .

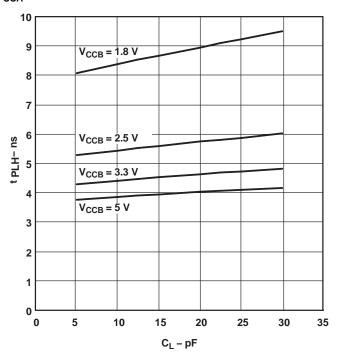
Table 1. Typical Total Static Power Consumption (I_{CCA} + I_{CCB})

| V | | | V _{CCA} | | | UNIT |
|------------------|-----|-------|------------------|-------|-----|------|
| V _{CCB} | 0 V | 1.8 V | 2.5 V | 3.3 V | 5 V | UNII |
| 0 V | 0 | <1 | <1 | <1 | <1 | |
| 1.8 V | <1 | <2 | <2 | <2 | 2 | |
| 2.5 V | <1 | <2 | <2 | <2 | <2 | μΑ |
| 3.3 V | <1 | <2 | <2 | <2 | <2 | |
| 5 V | <1 | 2 | <2 | <2 | <2 | |

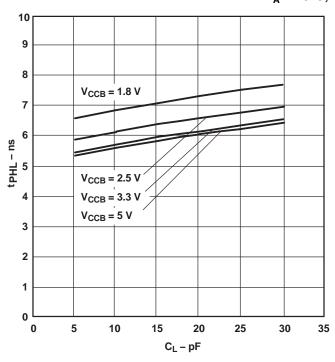
TYPICAL CHARACTERISTICS

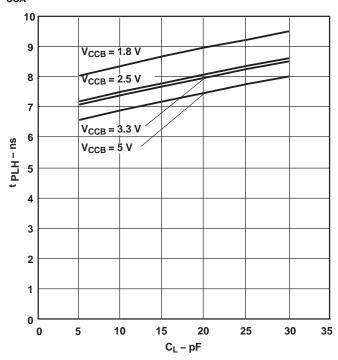
TYPICAL PROPAGATION DELAY (A to B) vs LOAD CAPACITANCE $T_A=25^{\circ}\text{C},\,V_{\text{CCA}}=1.8\;\text{V}$





TYPICAL PROPAGATION DELAY (B to A) vs LOAD CAPACITANCE $T_{A}=25^{\circ}\text{C},\,V_{CCA}=1.8\;\text{V}$

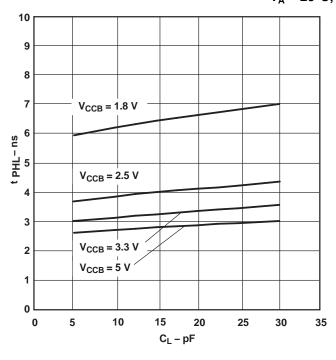


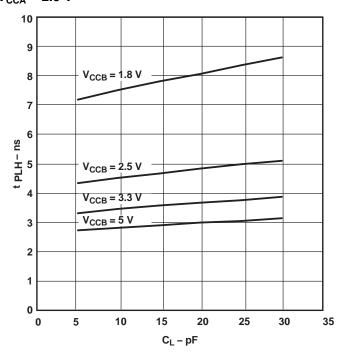




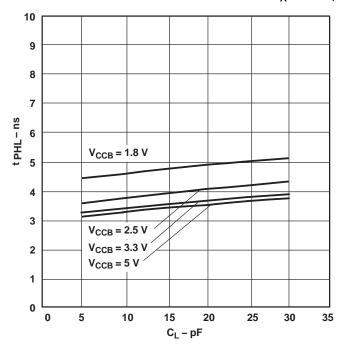
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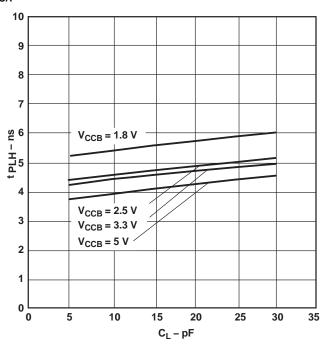
TYPICAL CHARACTERISTICS (continued) TYPICAL PROPAGATION DELAY (A to B) vs LOAD CAPACITANCE $T_{A}=25^{\circ}\text{C},\,V_{CCA}=2.5\,\text{V}$





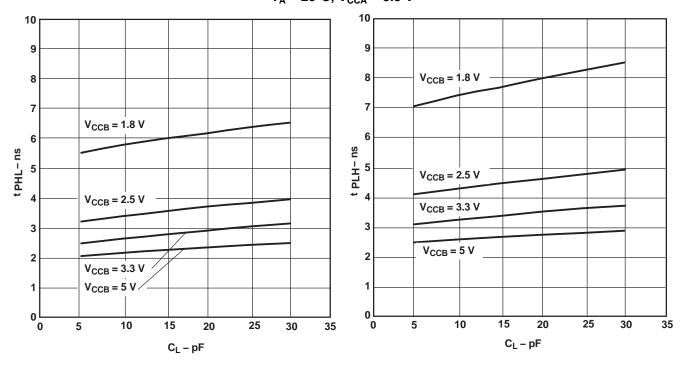
TYPICAL PROPAGATION DELAY (B to A) vs LOAD CAPACITANCE $T_A = 25^{\circ}C, V_{CCA} = 2.5 V$



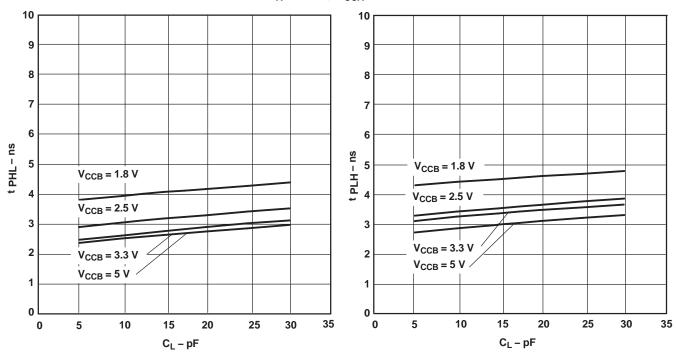


TYPICAL CHARACTERISTICS (continued)

TYPICAL PROPAGATION DELAY (A to B) vs LOAD CAPACITANCE T_{A} = 25°C, V_{CCA} = 3.3 V



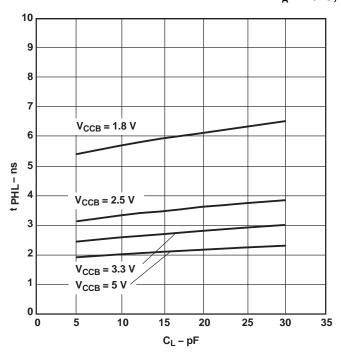
TYPICAL PROPAGATION DELAY (B to A) vs LOAD CAPACITANCE T_{A} = 25°C, V_{CCA} = 3.3 V

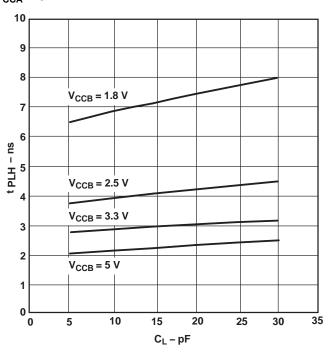




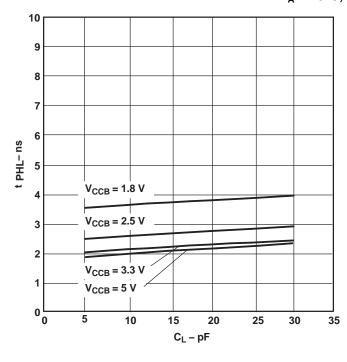
TYPICAL CHARACTERISTICS (continued)

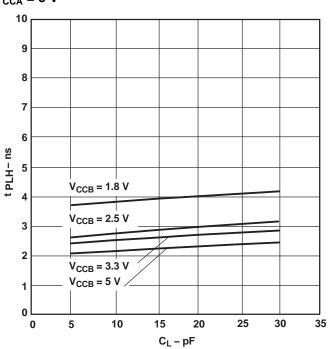
TYPICAL PROPAGATION DELAY (A to B) vs LOAD CAPACITANCE T_{A} = 25°C, V_{CCA} = 5 V





TYPICAL PROPAGATION DELAY (B to A) vs LOAD CAPACITANCE T_{A} = 25°C, V_{CCA} = 5 V

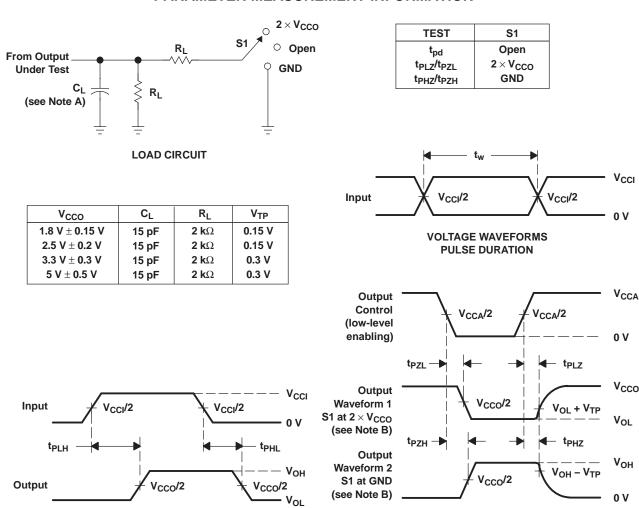




VOLTAGE WAVEFORMS

ENABLE AND DISABLE TIMES

PARAMETER MEASUREMENT INFORMATION



- NOTES: A. C_L includes probe and jig capacitance.
 - B. Waveform 1 is for an output with internal conditions such that the output is low, except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high, except when disabled by the output control.
 - C. All input pulses are supplied by generators having the following characteristics: PRR \leq 10 MHz, $Z_0 = 50 \Omega$, $dv/dt \geq 1 V/ns$.
 - D. The outputs are measured one at a time, with one transition per measurement.
 - E. t_{PLZ} and t_{PHZ} are the same as t_{dis} .
 - F. t_{PZL} and t_{PZH} are the same as t_{en}.
 - G. t_{PLH} and t_{PHL} are the same as t_{pd} .
 - H. V_{CCI} is the V_{CC} associated with the input port.
 - I. V_{CCO} is the V_{CC} associated with the output port.

VOLTAGE WAVEFORMS

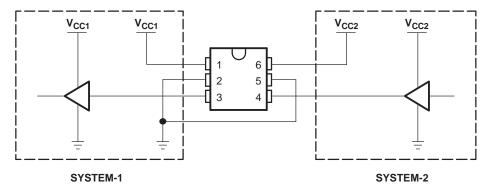
PROPAGATION DELAY TIMES

J. All parameters and waveforms are not applicable to all devices.

Figure 1. Load Circuit and Voltage Waveforms

APPLICATION INFORMATION

Figure 2 shows an example of the SN74LVC1T45 being used in a unidirectional logic level-shifting application.

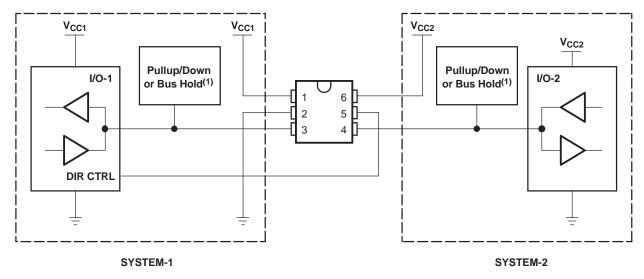


| PIN | NAME | FUNCTION | DESCRIPTION |
|-----|------------------|------------------|--|
| 1 | V _{CCA} | V _{CC1} | SYSTEM-1 supply voltage (1.65 V to 5.5 V) |
| 2 | GND | GND | Device GND |
| 3 | A | OUT | Output level depends on V _{CC1} voltage. |
| 4 | В | IN | Input threshold value depends on V _{CC2} voltage. |
| 5 | DIR | DIR | GND (low level) determines B-port to A-port direction. |
| 6 | V _{CCB} | V _{CC2} | SYSTEM-2 supply voltage (1.65 V to 5.5 V) |

Figure 2. Unidirectional Logic Level-Shifting Application

APPLICATION INFORMATION

Figure 3 shows the SN74LVC1T45 being used in a bidirectional logic level-shifting application. Since the SN74LVC1T45 does not have an output-enable (OE) pin, the system designer should take precautions to avoid bus contention between SYSTEM-1 and SYSTEM-2 when changing directions.



The following table shows data transmission from SYSTEM-1 to SYSTEM-2 and then from SYSTEM-2 to SYSTEM-1.

| STATE | DIR CTRL | I/O-1 | I/O-2 | DESCRIPTION |
|-------|----------|-------|-------|---|
| 1 | Н | Out | In | SYSTEM-1 data to SYSTEM-2 |
| 2 | Н | Hi-Z | Hi-Z | SYSTEM-2 is getting ready to send data to SYSTEM-1. I/O-1 and I/O-2 are disabled. The bus-line state depends on pullup or pulldown. (1) |
| 3 | L | Hi-Z | Hi-Z | DIR bit is flipped. I/O-1 and I/O-2 still are disabled. The bus-line state depends on pullup or pulldown. (1) |
| 4 | L | Out | In | SYSTEM-2 data to SYSTEM-1 |

(1) SYSTEM-1 and SYSTEM-2 must use the same conditions, i.e., both pullup or both pulldown.

Figure 3. Bidirectional Logic Level-Shifting Application

Enable Times

Calculate the enable times for the SN74LVC1T45 using the following formulas:

- t_{PZH} (DIR to A) = t_{PIZ} (DIR to B) + t_{PIH} (B to A)
- t_{P7I} (DIR to A) = t_{PH7} (DIR to B) + t_{PHI} (B to A)
- t_{PZH} (DIR to B) = t_{PLZ} (DIR to A) + t_{PLH} (A to B)
- t_{PZL} (DIR to B) = t_{PHZ} (DIR to A) + t_{PHL} (A to B)

In a bidirectional application, these enable times provide the maximum delay from the time the DIR bit is switched until an output is expected. For example, if the SN74LVC1T45 initially is transmitting from A to B, then the DIR bit is switched; the B port of the device must be disabled before presenting it with an input. After the B port has been disabled, an input signal applied to it appears on the corresponding A port after the specified propagation delay.





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PACKAGING INFORMATION

| Orderable Device | Status ⁽¹⁾ | Package Type | Package Drawing | Pins | Package Qty | e Eco Plan ⁽²⁾ | Lead/Ball Finish | MSL Peak Temp ⁽³⁾ |
|-------------------|-----------------------|-----------------|--------------------|------|----------------|---------------------------|------------------|------------------------------|
| SN74LVC1T45DBVR | ACTIVE | SOT-23 | DBV | 6 | 3000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| SN74LVC1T45DBVRE4 | ACTIVE | SOT-23 | DBV | 6 | 3000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| SN74LVC1T45DBVT | ACTIVE | SOT-23 | DBV | 6 | 250 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| SN74LVC1T45DBVTE4 | ACTIVE | SOT-23 | DBV | 6 | 250 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| SN74LVC1T45DCKR | ACTIVE | SC70 | DCK | 6 | 3000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| SN74LVC1T45DCKRE4 | ACTIVE | SC70 | DCK | 6 | 3000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| SN74LVC1T45DCKRG4 | ACTIVE | SC70 | DCK | 6 | 3000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| SN74LVC1T45DCKT | ACTIVE | SC70 | DCK | 6 | 250 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| SN74LVC1T45DCKTE4 | ACTIVE | SC70 | DCK | 6 | 250 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| SN74LVC1T45DCKTG4 | ACTIVE | SC70 | DCK | 6 | 250 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| SN74LVC1T45DRLR | ACTIVE | SOT-533 | DRL | 6 | 4000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| SN74LVC1T45DRLRG4 | ACTIVE | SOT-533 | DRL | 6 | 4000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| SN74LVC1T45YZPR | ACTIVE | WCSP | YZP | 6 | 3000 | Green (RoHS & no Sb/Br) | SNAGCU | Level-1-260C-UNLIM |

(1) The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

(3) MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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PACKAGE OPTION ADDENDUM

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DBV (R-PDSO-G6)

PLASTIC SMALL-OUTLINE PACKAGE



NOTES:

- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion. Mold flash and protrusion shall not exceed 0.15 per side.
- D. Leads 1,2,3 may be wider than leads 4,5,6 for package orientation.
- Falls within JEDEC MO-178 Variation AB, except minimum lead width.



DCK (R-PDSO-G6)

PLASTIC SMALL-OUTLINE PACKAGE



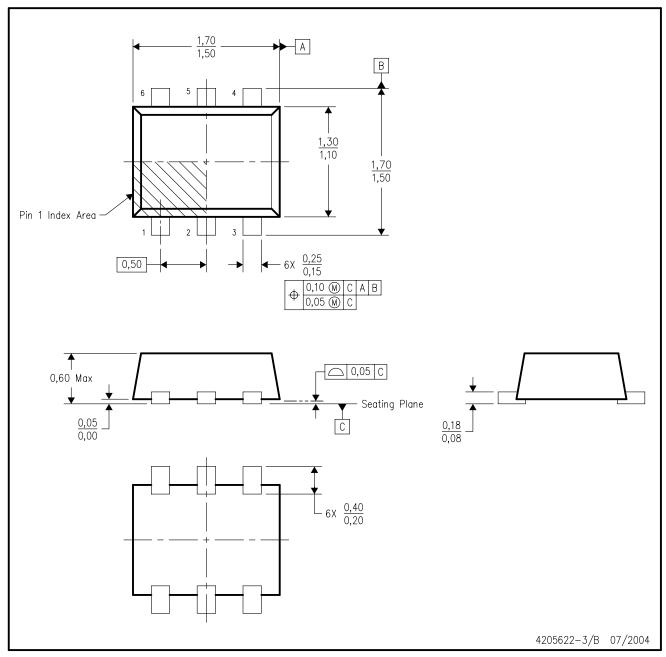
NOTES: A. All linear dimensions are in millimeters.

- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion. Mold flash and protrusion shall not exceed 0.15 per side.
- D. Falls within JEDEC MO-203 variation AB.



DRL (R-PDSO-N6)

PLASTIC SMALL OUTLINE



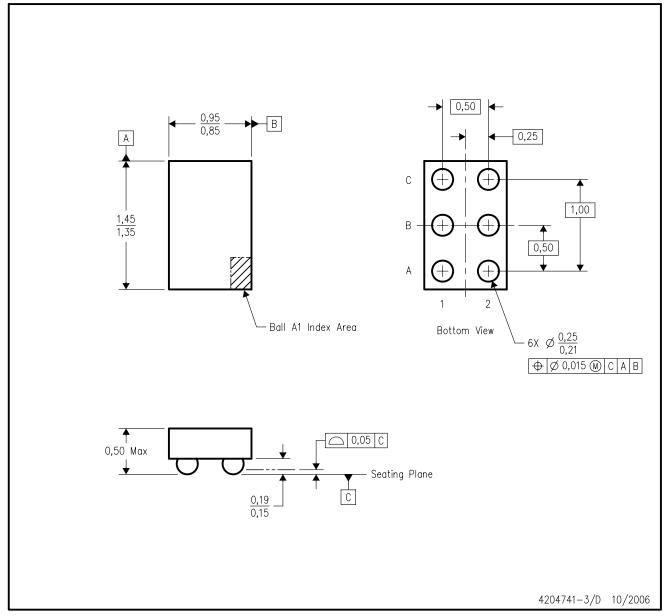
NOTES:

- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. JEDEC package registration is pending.



YZP (R-XBGA-N6)

DIE-SIZE BALL GRID ARRAY



NOTES: A. All linear dimensions are in millimeters. Dimensioning and tolerancing per ASME Y14.5M-1994.

- B. This drawing is subject to change without notice.
- C. NanoFree $^{\text{TM}}$ package configuration.
- D. This package is lead—free. Refer to the 6 YEP package (drawing 4204725) for tin—lead (SnPb).

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Post Office Box 655303 Dallas, Texas 75265